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Sept 2017

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FCA47N60F N-Channel SuperFET[®] FRFET[®] MOSFET

600 V, 47 A, 73 m Ω

Features

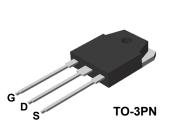
- 650 V @ T_J = 150 °C
- Typ. R_{DS(on)} = 62 mΩ
- Fast Recovery Time (Typ. T_{rr} = 240 ns)
- Ultra Low Gate Charge (Typ. Q_g = 210 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 420 pF)
- 100% Avalanche Tested
- RoHS Compliant

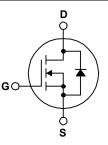
Applications

- Solar Inverter
- AC-DC Power Supply

Description

SuperFET[®] MOSFET is ON Semiconductor's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low onresistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. Super-FET FRFET[®] MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter			FCA47N60F	Unit	
V _{DSS}	Drain-Source Voltage	9		600	V	
ID	Drain Current - Continuous ($T_C = 25^{\circ}$ - Continuous ($T_C = 10^{\circ}$			47 29.7	A A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	141	A	
V _{GSS}	Gate-Source voltage			± 30	V	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	1800	mJ	
I _{AR}	Avalanche Current		(Note 1)	47	A	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	41.7	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	50	V/ns	
P _D	Power Dissipation	(T _C = 25°C) - Derate Above 25°C		417 3.33	W W/°C	
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

Symbol	Parameter	FCA47N60F	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	0.3	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	41.7	°C/W	

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Channel SuperFET
[®] FRFET [®] N
MOSFET

Part Number Top Mark P		Package	ackage Packing Method Reel Size		Та	pe Width	Qu	antity		
FCA4	FCA47N60F FCA47N60F T			Tube	N/A		N/A	30	30 units	
Electric	al Char	acteristics T _c = 25°C u	nless otherwise	noted						
Symbol		Parameter		Conditions			Тур.	Max.	Unit	
Off Charac	teristics									
BV _{DSS}	Drain-Source Breakdown Voltage		V _{GS} = 0	V_{GS} = 0 V, I _D = 250 µA, T _J = 25°C					V	
			V _{GS} = 0	V_{GS} = 0 V, I _D = 250 µA, T _J = 150°C			650		V	
ΔΒV _{DSS} / ΔT _J	Breakdow Coefficient	n Voltage Temperature t	I _D = 250	$I_D = 250 \ \mu$ A, Referenced to 25°C			0.6		V/∘C	
BV _{DS}	Drain to So Voltage	ource Avalanche Breakdowr	V _{GS} = 0	V _{GS} = 0 V, I _D = 47 A			700		V	
I _{DSS}	Zero Gate	Voltage Drain Current		$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V},$ $V_{DS} = 480 \text{ V}, T_{C} = 125^{\circ}\text{C}$				10 100	μΑ μΑ	
I _{GSSF}	Gate-Body	/ Leakage Current, Forward	eakage Current, Forward V_{GS} = 30 V, V_{DS} = 0 V					100	nA	
I _{GSSR}	Gate-Body	/ Leakage Current, Reverse	V _{GS} = -:	V _{GS} = -30 V, V _{DS} = 0 V				-100	nA	
On Charac	teristics		1		l		1 1			
V _{GS(th)}	Gate Thre	shold Voltage	V _{DS} = V	V_{DS} = V_{GS} , I_D = 250 μ A				5.0	V	
R _{DS(on)}	Static Drain-Source On-Resistance		V _{GS} = 1	V _{GS} = 10 V, I _D = 23.5 A			0.062	0.073	Ω	
9 _{FS}	Forward T	ransconductance	V _{DS} = 2	V _{DS} = 20 V, I _D = 23.5 A			40		S	
Dynamic C	haracterist	ics	1		l		1 1			
C _{iss}	Input Capa	acitance		V _{DS} = 25 V, V _{GS} = 0 V,			5900	8000	pF	
C _{oss}	Output Ca	tput Capacitance		f = 1 MHz			3200	4200	pF	
C _{rss}	Reverse T	ransfer Capacitance					250		pF	
C _{oss}	Output Ca	pacitance	V _{DS} = 4	V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz			160		pF	
Coss(eff.)	Effective C	Output Capacitance	V _{DS} = 0	$V_{\rm DS}$ = 0 V to 400 V, $V_{\rm GS}$ = 0 V			420		pF	
Switching	Characteris	stics	1		l		1 1			
t _{d(on)}	Turn-On D	elay Time		V_{DD} = 300 V, I _D = 47 A, V_{GS} = 10 V, R _G = 25 Ω (Note 4)			185	430	ns	
t _r	Turn-On R	lise Time	V _{GS} = 1				210	450	ns	
t _{d(off)}	Turn-Off D	elay Time					520	1100	ns	
t _f	Turn-Off F	all Time					75	160	ns	
Q _g	Total Gate	Charge	V _{DS} = 4	V_{DS} = 480 V, I _D = 47 A, V _{GS} = 10 V			210	270	nC	
Q _{gs}	Gate-Sour	ce Charge	V _{GS} = 1				38		nC	
Q _{gd}	Gate-Drain	n Charge			(Note 4)		110		nC	
	rce Diode C	haracteristics and Maximu	Im Ratings	6			ı — I		<u>.</u>	
I _S	Maximum Continuous Drain-Source Diode Forward Current					47	Α			
I _{SM}	Maximum	Maximum Pulsed Drain-Source Diode Forward Current					141	Α		
V _{SD}	Drain-Sou	rce Diode Forward Voltage	V _{GS} = 0	V _{GS} = 0 V, I _S = 47 A				1.4	V	
t _{rr}	Reverse R	Recovery Time		V, I _S = 47 A,			240		ns	
Q _{rr}	Poverse F	ecovery Charge	dI _F /dt =	$dI_F/dt = 100 A/\mu s$			2.04		μC	

Notes:

1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. I_{AS} = 18 A, V_{DD} = 50 V, R_{G} = 25 $\Omega,$ starting T_{J} = 25°C.

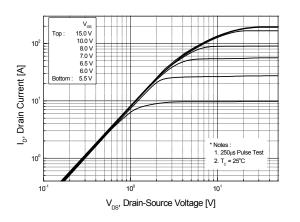
3. I_{SD} \leq 47 A, di/dt \leq 1200 A/µs, V_{DD} \leq BV_{DSS}, starting T_J = 25°C.

4. Essentially independent of operating temperature typical characteristics.

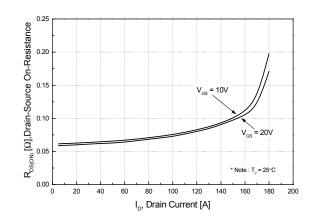
Typical Performance Characteristics



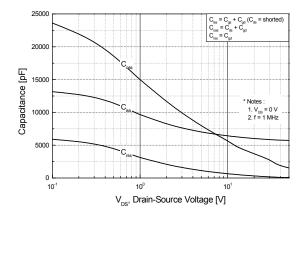
Figure 2. Transfer Characteristics

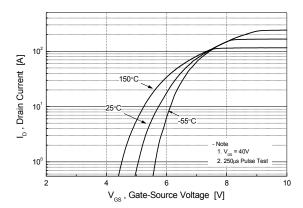




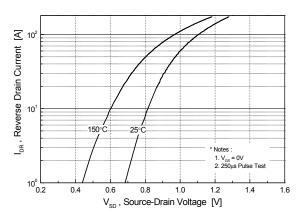




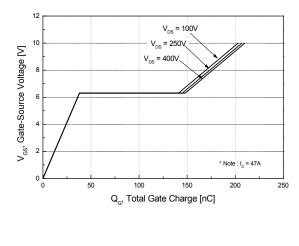


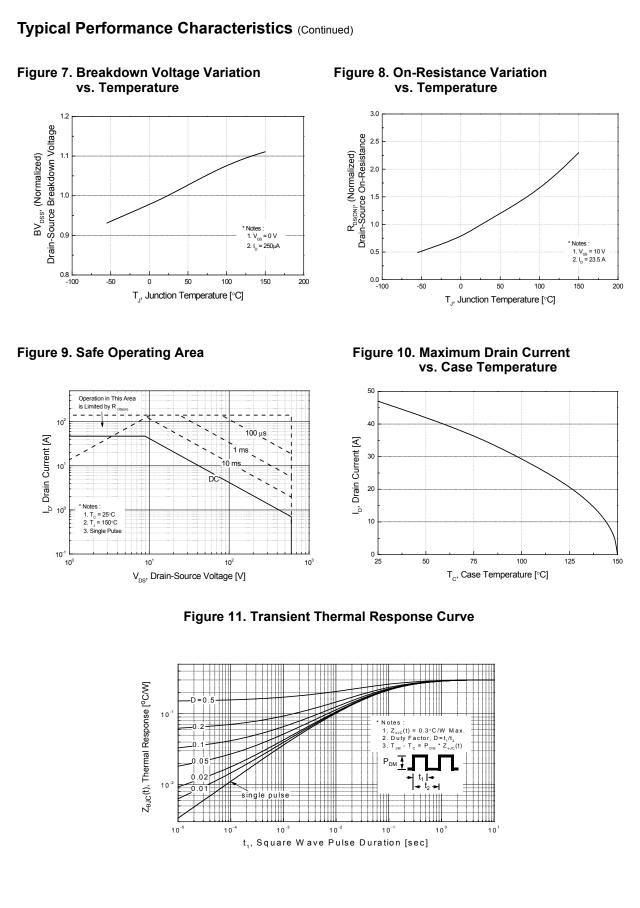


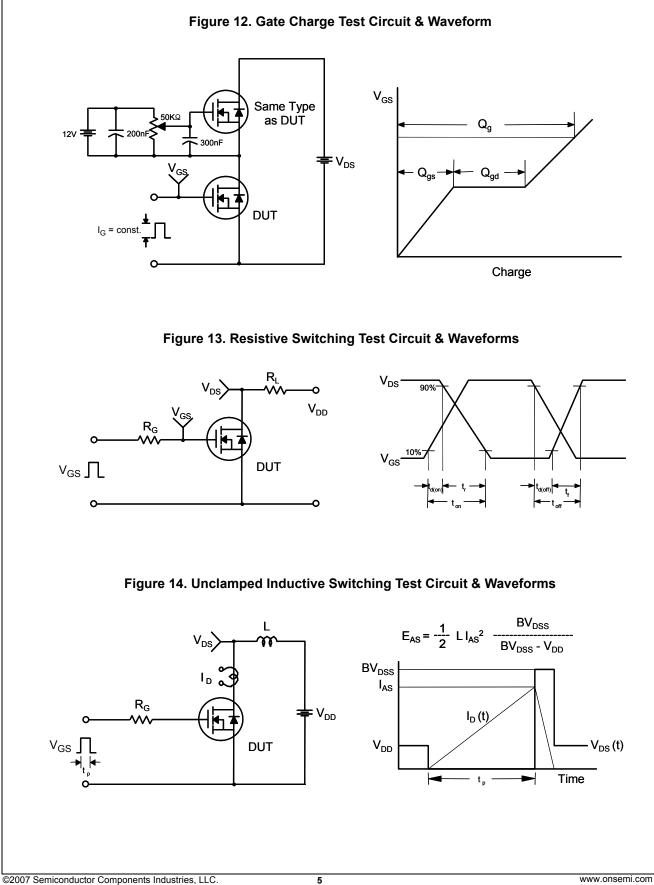






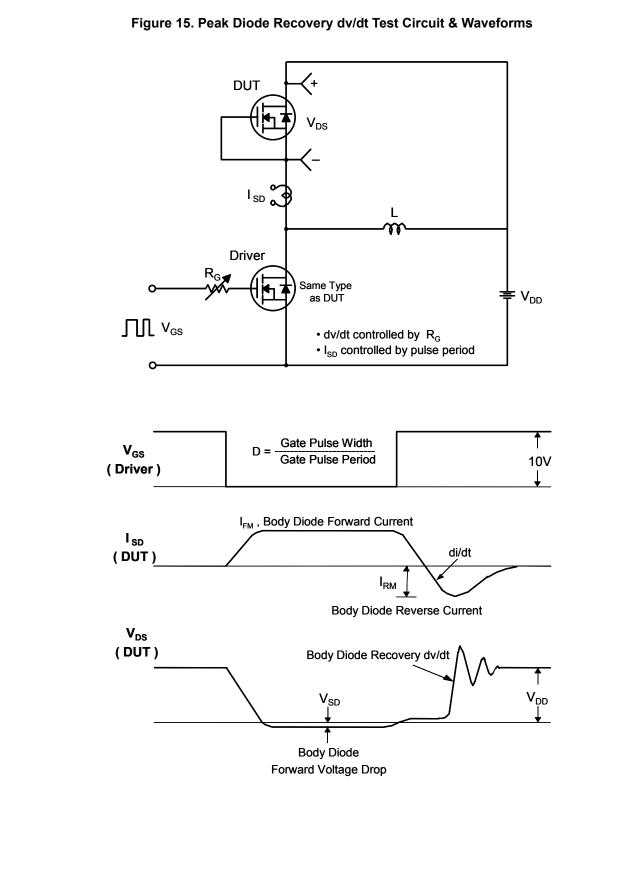






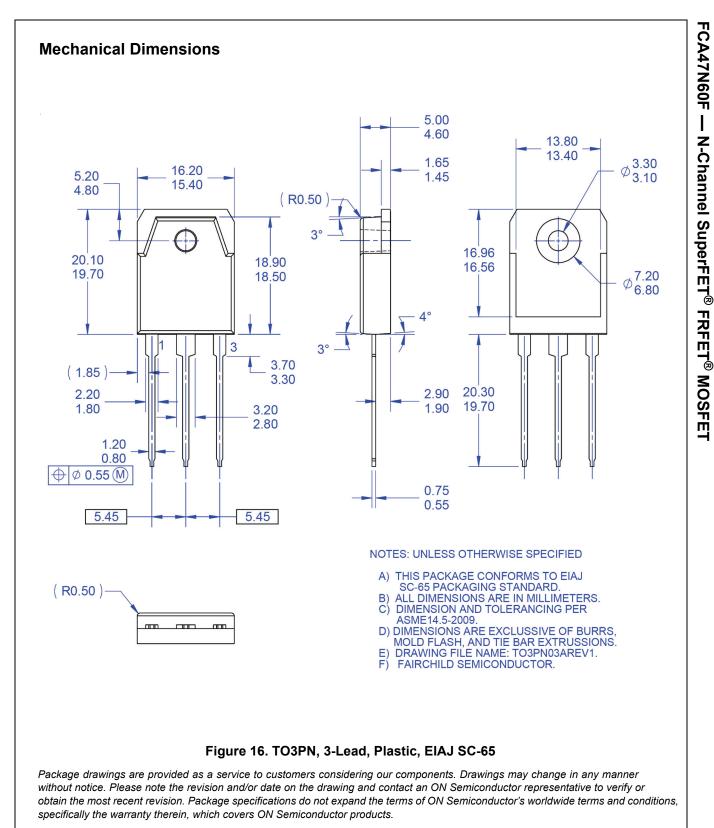
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